

UNISONIC TECHNOLOGIES CO., LTD

## 2N7002W

Preliminary

# 300m Amps, 60 Volts N-CHANNEL POWER MOSFET

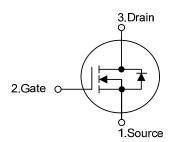
## DESCRIPTION

The UTC **2N7002W** has been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. It can be used in most applications requiring up to 400mA DC and can deliver pulsed currents up to 2A. The product is particularly suited for low voltage, low current applications, such as small servo motor control, power MOSFET gate drivers, and other switching applications

## FEATURES

- \* High Density Cell Design for Low R<sub>DS(ON)</sub>.
- \* Voltage Controlled Small Signal Switch
- \* Rugged and Reliable
- \* High Saturation Current Capability

#### SYMBOL

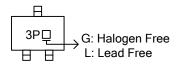


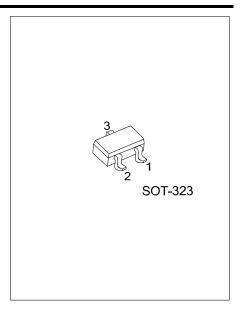
## ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Docking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
2N7002WL-AL3-R	2N7002WG-AL3-R	SOT-323	S	G	D	Tape Reel	

2N7002WG- <u>AL3-R</u>	(1)Packing Type	(1) R: Tape Reel
	(2)Package Type	(2) AL3: SOT-323
	(3)Halogen Free	(3) G: Halogen Free, L: Lead Free

#### MARKING





#### ■ **ABSOLUTE MAXIMUM RATINGS** (Ta=25°C unless otherwise noted.)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V <sub>DSS</sub> 60		V	
Drain-Gate Voltage (R <sub>GS</sub> ≤1	ΜΩ)	V <sub>DGR</sub>	60	V
Gate Source Voltage	Continuous	V <sub>GSS</sub>	±20	V
Gale Source vollage	Non Repetitive(tp<50µs)	VGSS	±40	v
Drain Current	Continuous	1_	300	mA
	Pulsed	I <sub>D</sub>	60   60   ±20   ±40   300   800   200	IIIA
Power Dissipation		D-	200	mW
Derated Above 25°C		P <sub>D</sub> 1.6		mW/°C
Junction Temperature		TJ	+ 150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

#### THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ <sub>JA</sub>	625 (Note1)	°C/W	

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS		·				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =10µA	60			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μA
Cata Source Lookage Current	I <sub>GSSF</sub>	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V			100	nA
Gate-Source Leakage Current	I <sub>GSSR</sub>	V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-	nA
ON CHARACTERISTICS (Note2)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =250μA	1	2.1	2.5	V
Drain-Source On-Voltage		V <sub>GS</sub> = 10V, I <sub>D</sub> =500mA		0.6	1     100     -100     2.5     3.75     1.5     13.5     7.5     50     25     5     20	v
Drain-Source On-voltage	V <sub>DS (ON)</sub>	V <sub>GS</sub> = 5.0V, I <sub>D</sub> =50mA		0.09		v
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> =10V,V <sub>DS</sub> ≥2V <sub>DS(ON)</sub>	500	2700		mA
Static Drain-Source On-Resistance	D	V <sub>GS</sub> =10V, I <sub>D</sub> =500mA ,T <sub>j</sub> =125°C			13.5	Ω
Static Drain-Source On-Resistance	V <sub>GS</sub> =5.0V, I <sub>D</sub> =50mA 7.5	Ω				
DYNAMIC CHARACTERISTICS		·				
Input Capacitance	CISS	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,f=1.0MHz		20	50	pF
Output Capacitance	Coss			11	25	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			4	5	pF
Turn-On Time	t <sub>on</sub>	V <sub>DD</sub> =30V, R <sub>L</sub> =150Ω I <sub>D</sub> =200mA, V <sub>GS</sub> =10V R <sub>GEN</sub> =25Ω			20	nS
Turn-Off Time	toff	$V_{DD}$ =30V, R <sub>L</sub> =25Ω I <sub>D</sub> =200mA, V <sub>GS</sub> =10V R <sub>GEN</sub> =25Ω			20	nS
DRAIN-SOURCE DIODE CHARACTERIS	STICS AND N	MAXIMUM RATINGS				
Drain-Source Diode Forward Voltage	$V_{SD}$	V <sub>GS</sub> =0V, Is=115mA (Note)		0.88	1.5	V
Maximum Pulsed Drain-Source Diode Forward Current	I <sub>SM</sub>				0.8	А
Maximum Continuous Drain-Source Diode Forward Current	ls				115	mA

Note: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size.

2. Pulse Test: Pulse Width≤300µs, Duty Cycle≤2.0%



## **TEST CIRCUIT AND WAVEFORM**

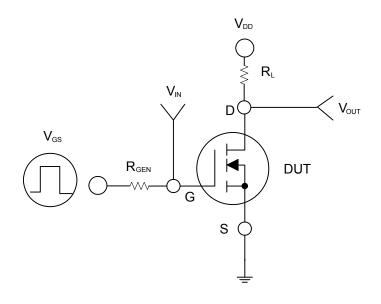


Figure 1

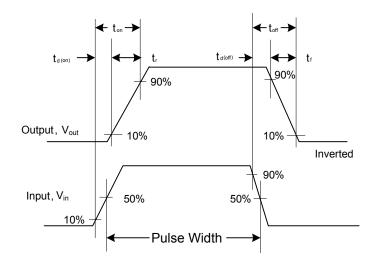


Figure 2. Switching Waveforms

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